



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
	160mΩ @ V _{GS} = -4.5V	-2.4A
-20V	210mΩ @ V _{GS} = -2.5V	-2.1A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Backlighting
- **Power Management Functions**
- **DC-DC Converters**
- Motor Control

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

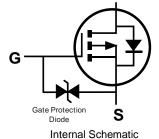
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish —Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminals Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)

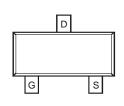




Top View







Top View

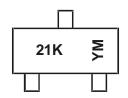
Ordering Information (Note 4)

Part Number	Case	Packaging
DMG2301LK-7	SOT23	3,000/Tape & Reel
DMG2301LK-13	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



21K = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

Year	2016		2017	2018		2019	2020		2021	2022		2023
Code	D		Е	F		G	Н		ı	J		K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±12	V
Continuous Drain Current (Note 6) V _{GS} = -4.5V	I _D	-2.4 -1.9	Α	
Maximum Continuous Body Diode Forward Curre	ent (Note 6)	Is	-1.12	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	1%)	I _{DM}	-8	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	0.84	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	150	°C/W
Total Power Dissipation (Note 6)		P _D	1.40	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	91	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified)

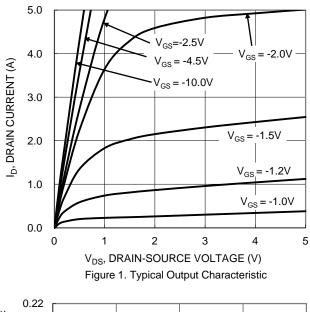
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current (T _J = +25°C)	I _{DSS}	_	_	-10	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.3	-0.6	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250A$	
			136	160		$V_{GS} = -4.5V$, $I_D = -1.0A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	183	210	mΩ	$V_{GS} = -2.5V, I_D = -1.0A$	
			229	298		$V_{GS} = -1.8V, I_D = -0.2A$	
Diode Forward Voltage	V_{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -1.0A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	156	_	pF		
Output Capacitance	Coss	_	36	_	pF	$V_{DS} = -6V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	28	_	pF	1 = 1.0WHZ	
Gate Resistance	R_g	_	41	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	1.6	_	nC		
Total Gate Charge (V _{GS} = -10V)	Q_g	_	3.4	_	nC	$V_{DS} = -6V$,	
Gate-Source Charge	Qgs	_	0.3	_	nC	I _D = -2.2A	
Gate-Drain Charge	Q_{gd}	_	0.4	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.2	_	ns		
Turn-On Rise Time	t _R	_	7.4	_	ns	$V_{DS} = -6V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	11.0	_	ns	$R_{GEN} = 6 \Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _F	_	10.5	_	ns	1	
Reverse Recovery Time	t _{RR}	_	6.5	_	ns	1 4 0 4 4 4 4 0 0 0 4 1 1 2	
Reverse Recovery Charge	Q_{RR}	_	0.8	_	nC	$I_F = -1.0A$, di/dt = 100A/ μ s	

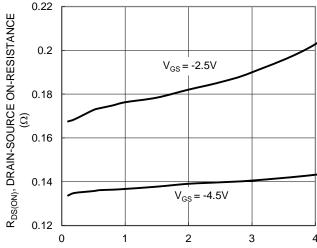
5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

- 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided. 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

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I_D, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

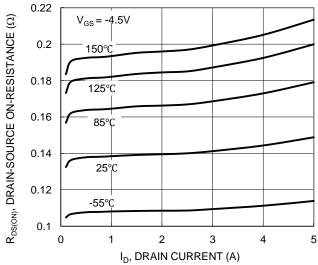
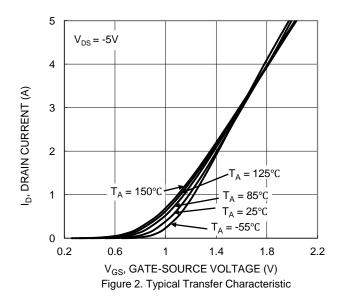
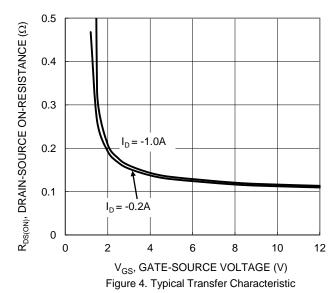
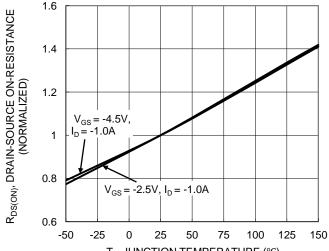


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature







T_J, JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature



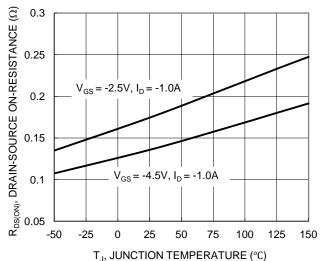
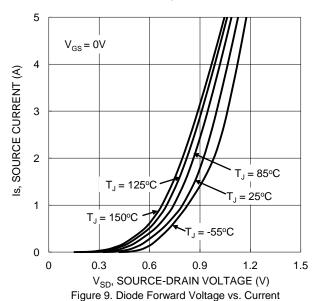
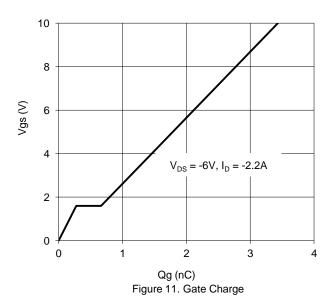


Figure 7. On-Resistance Variation with Junction Temperature





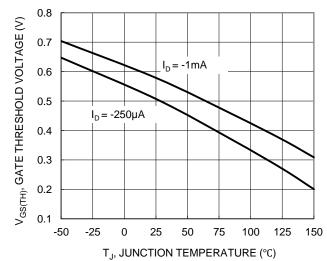
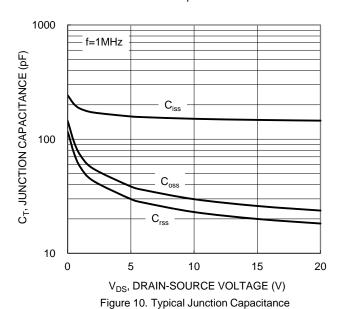


Figure 8. Gate Threshold Variation vs. Junction Temperature



 $\begin{array}{c} 10 \\ \hline \\ R_{DS(ON)} \text{ Limited} \\ \hline \\ P_W = 100 \\ \hline \\ O.01 \\ \hline \\ O.02 \\ \hline \\ O.03 \\ \hline \\ O.03 \\ \hline \\ O.04 \\ \hline \\ O.05 \\ \hline \\ O.0$

Figure 12. SOA, Safe Operation Area



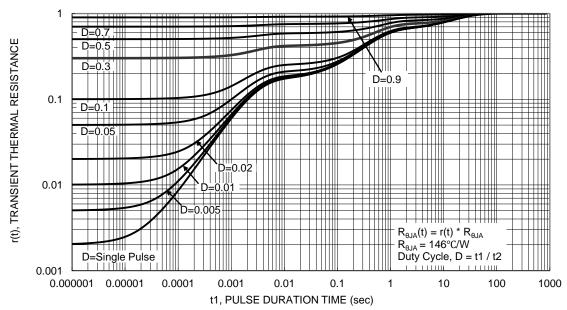


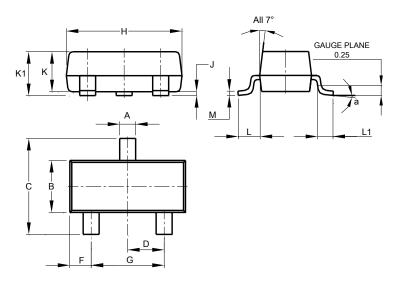
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

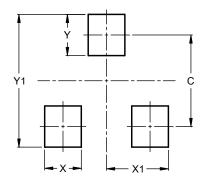


SOT23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
C	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
M	0.085	0.150	0.110					
а	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)				
С	2.0				
Х	0.8				
X1	1.35				
Υ	0.9				
Y1	2.9				



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